Scope

This specification is applied to multicomp thermoelectric modules
Revision of these specifications is carried out after consent

Specifications

<table>
<thead>
<tr>
<th>Parameters</th>
<th>Remarks</th>
</tr>
</thead>
<tbody>
<tr>
<td>Internal resistance</td>
<td>1 Ω ±10%</td>
</tr>
<tr>
<td>I max.</td>
<td>12 A</td>
</tr>
<tr>
<td>V max.</td>
<td>15.4 V</td>
</tr>
<tr>
<td>Qc max.</td>
<td>110 W</td>
</tr>
<tr>
<td>∆T max.</td>
<td>68°C</td>
</tr>
<tr>
<td>Solder melting point</td>
<td>138°C</td>
</tr>
<tr>
<td>Maximum compress</td>
<td>98.07 N / cm² (10 kgf / cm²)</td>
</tr>
</tbody>
</table>

Note-1 : Measured by AC 4 - terminal method at 25°C
Note-2 : Maximum current at ∆T max.
Note-3 : Maximum voltage at ∆T max.
Note-4 : Maximum cooling capacity at I max. V max. and ∆T = 0°C
Note-5 : Maximum temperature difference at I max. V max. and Q = 0 W
(Maximum parameters are measured in a vacuum 1.3 P)
Note-6 : The solder melting point of thermoelectric module
Note-7 : Recommended maximum compression (not destruction limit)

Recommendations:

Operating range : -40°C to +90°C
Dropping or exerting mechanical shock will cause breakage, take care in handling
Thinly spread thermally conductive grease should be placed between module and heat exchanger
Surface deviation from flatness should be kept under 0.02 mm
For optimum reliability and performance it is recommended that the module be utilised < 0.7 I max.
Silicone sealed for moisture protection

Specification Table

<table>
<thead>
<tr>
<th>I max. (A)</th>
<th>U max. (V)</th>
<th>Qc max. W</th>
<th>∆T max. °C</th>
<th>A</th>
<th>B</th>
<th>H</th>
<th>Part Number</th>
</tr>
</thead>
<tbody>
<tr>
<td>12</td>
<td>15.4</td>
<td>110</td>
<td>68</td>
<td>40</td>
<td>40</td>
<td>3.7</td>
<td>MCTE1-12712L-S</td>
</tr>
</tbody>
</table>

Thot = 27°C

Dimensions : Millimetres
Thermoelectric Module

Outline Drawing

Dimensions: Millimetres

40 ±0.3

3.7 ±0.1

12712

Hot Side

Cold Side

Black (-)  Red (+)

100 ±5

7 ±3

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